

Product Change Notification / RMES-16DAKA328

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17-Jun-2021

Product Category:

Linear Regulators

PCN Type:

Manufacturing Change

Notification Subject:

CCB 4696 Final Notice: Qualification of C194 as an additional lead frame material for MCP1702, MCP1703x, MCP1754S and MCP1792 device families available in 3L SOT-23A package at LPI assembly site

Affected CPNs:

RMES-16DAKA328_Affected_CPN_06172021.pdf RMES-16DAKA328_Affected_CPN_06172021.csv

Notification Text:

PCN Status: Final notification

PCN Type:Manufacturing Change

Microchip Parts Affected: Please open one of the files found in the Affected CPNs section.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

Description of Change:Qualification of C194 as an additional lead frame material for MCP1702, MCP1703x, MCP1754S and MCP1792 device families available in 3L SOT-23A package at LPI assembly site

Pre and Post Change Summary:

	Pre Change	Post Change
Assembly Site	Lingsen Precision Industires, Taiwan. (LPI)	Lingsen Precision Industires, Taiwan. (LPI)

Wire material	Au	Au			
Lead frame material	EFTEC64T	EFTEC64T	C194		
Die attach material	84-3J	84-3J			
Molding compound material	G600	G600			

Impacts to Data Sheet:

None

Change Impact:None

Reason for Change:To improve on time delivery performance by qualifying C194 as an additional lead frame material.

Change Implementation Status:In Progress

Estimated First Ship Date: April 3, 2022 (date code: 2215)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	June 2021				April 2022						
Workweek	2 3	2 4	2 5	2 6	27	^	14	15	16	17	18
Final PCN Issue Date			Х								
Qual Report Availability			Χ								
Estimated Implementation Date								Х			

Method to Identify Change:Traceability code

Qualification Report: Please open the attachments included with this PCN labeled as PCN_#_Qual_Report.

Revision History:

June 17, 2021: Issued final notification. Attached the qualification report and added estimated first ship date by April 3, 2022.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachments:

PCN_RMES-16DAKA328_Qual_Report.pdf	
Please contact your local Microchip sales office with questions or concerns regarding this notification.	
Terms and Conditions:	
If you wish to <u>receive Microchip PCNs via email</u> please register for our PCN email service at our <u>PCN</u> home page select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the <u>PCN FAQ</u> section.	
If you wish to <u>change your PCN profile</u> , <u>including opt out</u> , please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.	

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Affected Catalog Part Numbers (CPN)

MCP1702T-4002E/CBVAO

MCP1703T-3302E/CBVAO

MCP1703T-5002E/CBVAO

MCP1703AT-3302E/CBVAO

MCP1703AT-5002E/CBVAO

MCP1754ST-5002E/CBVAO

MCP1792T-5002H/CBVAO

MCP1792T-3302H/CBVAO

MCP1792T-4102H/CBVAO

Date: Wednesday, June 16, 2021